

Yukihiro KIUCHI et al.

R E M A R K S

The above change in the claim merely place this national phase application in the same condition as it was during the international phase, with the multiple dependency being removed.

Attached hereto is a marked-up version of the change made to the claim by the current amendment. The attached page is captioned "VERSION WITH MARKINGS TO SHOW CHANGES MADE".

Respectfully submitted,

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VERSION WITH MARKINGS TO SHOW CHANGES MADE

13. A semiconductor device in which the epoxy resin composition described in ~~any one of~~ claims 1 to 12 is used as a encapsulating resin.

EPOXY RESIN COMPOSITION